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- B.S. course
 - Mechanical Engineering
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 - Research interest: Thermal management for chiplet packaging
Optimization of jet impingement cooling using ANN
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Academic Experiences

Korea University B.S. (2019.02 – Present)

Journal Publications:

Conference Presentations:

Award:

Patent:

Research Topics:

- 1) Thermal management for chiplet packaging
- 2) Optimization of jet impingement cooling using ANN